

### Description

The ULN2002A, ULN2003A and ULN2004A are high voltage, high current Darlington arrays each containing seven open collector common emitter pairs. Each pair is rated at 500mA. Suppression diodes are included for inductive load driving, the inputs and outputs are pinned in opposition to simplify board layout.

Device options are designed to be compatible with common logic families:

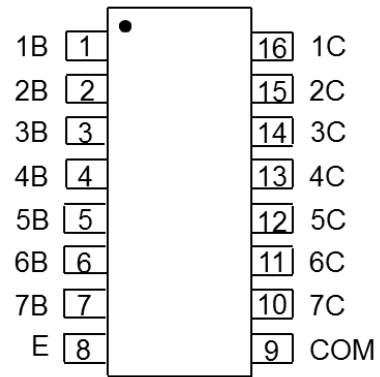
- ULN2002A (14-25V PMOS)
- ULN2003A (5V TTL, CMOS)
- ULN2004A (6-15V CMOS, PMOS)

These devices are capable of driving a wide range of loads including solenoids, relays, DC motors, LED displays, filament lamps, thermal print-heads and high-power buffers.

The ULN2002A, 2003A and 2004A are available in both a small outline 16-pin package (SO-16) and DIP-16 package.

### Pin Assignments

( Top View )



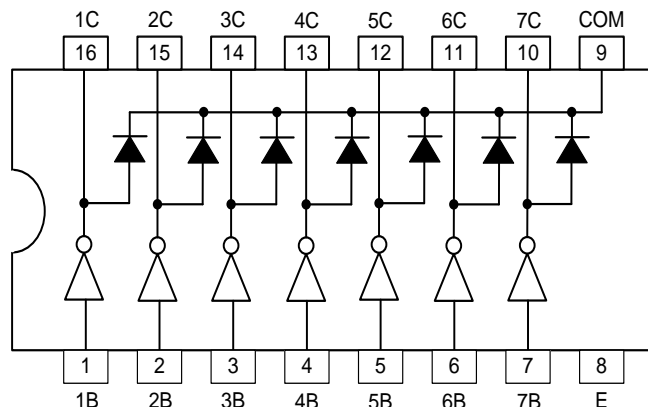
**SO-16/DIP-16**

### Features

- 500mA Rated Collector Current (single output)
- High Voltage Outputs: 50V
- Output Clamp Diodes
- Inputs Compatible with Popular Logic Types
- Relay Driver Applications
- "Green" Molding Compound (No Br, Sb)
- **Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

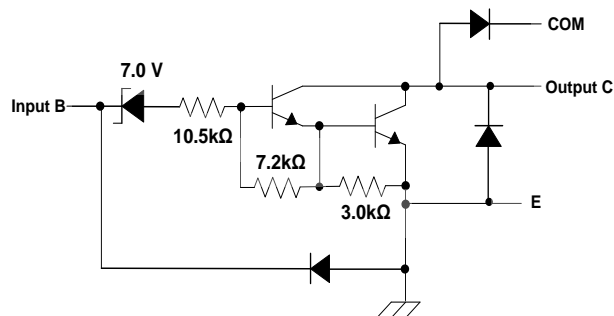
- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

### Connection Diagram

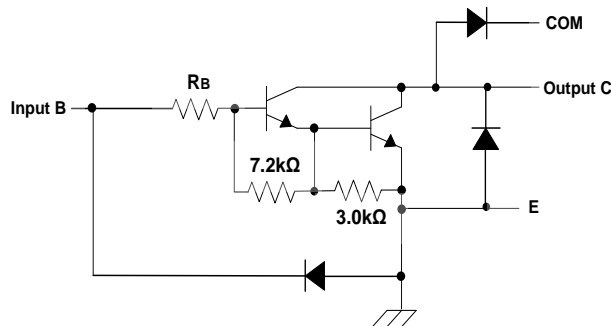


**Pin Descriptions**

Pin Number	Pin Name	Function
1	1B	Input Pair 1
2	2B	Input Pair 2
3	3B	Input Pair 3
4	4B	Input Pair 4
5	5B	Input Pair 5
6	6B	Input Pair 6
7	7B	Input Pair 7
8	E	Common Emitter (ground)
9	COM	Common Clamp Diodes
10	7C	Output Pair 7
11	6C	Output Pair 6
12	5C	Output Pair 5
13	4C	Output Pair 4
14	3C	Output Pair 3
15	2C	Output Pair 2
16	1C	Output Pair 1

**Functional Block Diagram**

ULN2002A



ULN2003A:  $R_B = 2k7$   
ULN2004A:  $R_B = 10k5$   
ULN2003A, ULN2004A

**Absolute Maximum Ratings** (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter		Rating	Unit
V <sub>CC</sub>	Collector to Emitter Voltage		50	V
V <sub>R</sub>	Clamp Diode Reverse Voltage (Note 5)		50	V
V <sub>I</sub>	Input Voltage (Note 5)		30	V
I <sub>CP</sub>	Peak Collector Current	See typical characteristics	500	mA
I <sub>OK</sub>	Output Clamp Current		500	mA
I <sub>TE</sub>	Total Emitter Current		-2.5	A
θ <sub>JA</sub>	Thermal Resistance Junction-to-Ambient (Note 6)	SO-16	63.0	°C/W
		DIP-16	50.0	
θ <sub>JC</sub>	Thermal Resistance Junction-to-Case (Note 6)	SO-16	12.0	°C/W
		DIP-16	15.0	
T <sub>J</sub>	Junction Temperature		150	°C
T <sub>STG</sub>	Storage Temperature		-65 to +150	°C

- Notes:
- Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
  - All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.
  - Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> – T<sub>A</sub>)/θ<sub>JA</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.
  - Maximum power dissipation is a function of T<sub>J(max)</sub>, θ<sub>JC</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any allowable ambient temperature is P<sub>D</sub> = (T<sub>J(max)</sub> – T<sub>C</sub>)/θ<sub>JC</sub>. Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.

**Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	Collector to Emitter voltage	-	50	V
T <sub>A</sub>	Operating Ambient Temperature	-40	+105	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

ULN2002A								
Parameter		Test Figure	Test Conditions	Min	Typ	Max	Unit	
V <sub>I(on)</sub>	On State Input Voltage	6	V <sub>CE</sub> = 2V, I <sub>C</sub> = 300mA	-	-	13	V	
V <sub>CE(sat)</sub>	Collector Emitter Saturation Voltage	5	I <sub>I</sub> = 250μA, I <sub>C</sub> = 100mA	-	0.9	1.1	V	
			I <sub>I</sub> = 350μA, I <sub>C</sub> = 200mA	-	1	1.3		
			I <sub>I</sub> = 500μA, I <sub>C</sub> = 350mA	-	1.2	1.6		
V <sub>F</sub>	Clamp Forward Voltage	8	I <sub>F</sub> = 350mA	-	1.7	2	V	
I <sub>CEX</sub>	Collector Cut-off Current	1	V <sub>CE</sub> = 50V, I <sub>I</sub> = 0	-	-	50	μA	
		2	V <sub>CE</sub> = 50V, T <sub>A</sub> = +105°C, I <sub>I</sub> = 0, V <sub>I</sub> = 6V	-	-	100		
I <sub>I(off)</sub>	Off State Input Current	3	V <sub>CE</sub> = 50V, I <sub>C</sub> = 500μA	50	65	-	μA	
I <sub>I</sub>	Input Current	4	V <sub>I</sub> = 17V	-	0.82	1.25	mA	
I <sub>R</sub>	Clamp Reverse Current	7	V <sub>R</sub> = 50V	T <sub>A</sub> = +105°C	-	-	100	μA
				-	-	-	50	
C <sub>I</sub>	Input Capacitance	-	V <sub>I</sub> = 0, f = 1MHz	-	-	25	pF	

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

<b>ULN2003A</b>									
<b>Parameter</b>		<b>Test Figure</b>	<b>Test Conditions</b>		<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>	
$V_{I(on)}$	On State Input Voltage	6	$V_{CE} = 2V$	$I_C = 200\text{mA}$	-	-	2.4	V	
				$I_C = 250\text{mA}$	-	-	2.7		
				$I_C = 300\text{mA}$	-	-	3		
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	5		$I_I = 250\mu\text{A}, I_C = 100\text{mA}$	-	0.9	1.1	V	
				$I_I = 350\mu\text{A}, I_C = 200\text{mA}$	-	1	1.3		
				$I_I = 500\mu\text{A}, I_C = 350\text{mA}$	-	1.2	1.6		
$V_F$	Clamp Forward Voltage	8		$I_F = 350\text{mA}$	-	1.7	2	V	
$I_{CEX}$	Collector Cut-off Current	1		$V_{CE} = 50V, I_I = 0$	-	-	50	$\mu\text{A}$	
		2		$V_{CE} = 50V, T_A = +105^\circ\text{C}$	$I_I = 0$	-	-		100
$I_{I(off)}$	Off State Input Current	3		$V_{CE} = 50V, I_C = 500\mu\text{A}$	50	65	-	$\mu\text{A}$	
$I_I$	Input Current	4		$V_I = 3.85V$	-	0.93	1.35	mA	
$I_R$	Clamp Reverse Current	7		$V_R = 50V$	$T_A = +105^\circ\text{C}$	-	-	100	$\mu\text{A}$
						-	-	50	
$C_I$	Input Capacitance	-		$V_I = 0, f = 1\text{MHz}$	-	15	25	pF	
<b>ULN2004A</b>									
<b>Parameter</b>		<b>Test Figure</b>	<b>Test Conditions</b>		<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>	
$V_{I(on)}$	On State Input Voltage	6	$V_{CE} = 2V$	$I_C = 125\text{mA}$	-	-	5	V	
				$I_C = 200\text{mA}$	-	-	6		
				$I_C = 275\text{mA}$	-	-	7		
				$I_C = 350\text{mA}$	-	-	8		
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	5		$I_I = 250\mu\text{A}, I_C = 100\text{mA}$	-	0.9	1.1	V	
				$I_I = 350\mu\text{A}, I_C = 200\text{mA}$	-	1	1.3		
				$I_I = 500\mu\text{A}, I_C = 350\text{mA}$	-	1.2	1.6		
$V_F$	Clamp Forward Voltage	8		$I_F = 350\text{mA}$	-	1.7	2	V	
$I_{CEX}$	Collector Cut-off Current	1		$V_{CE} = 50V, I_I = 0$	-	-	50	$\mu\text{A}$	
		2		$V_{CE} = 50V, T_A = +105^\circ\text{C}$	$I_I = 0$	-	-		100
				$V_I = 6V$	-	-	500		
$I_{I(off)}$	Off State Input Current	3		$V_{CE} = 50V, I_C = 500\mu\text{A}$	50	65	-	$\mu\text{A}$	
$I_I$	Input Current	4		$V_I = 5V$	-	0.35	0.5	mA	
$I_R$	Clamp Reverse Current	7		$V_R = 50V$	$T_A = +105^\circ\text{C}$	-	-	100	$\mu\text{A}$
						-	-	50	
$C_I$	Input Capacitance	-		$V_I = 0, f = 1\text{MHz}$	-	15	25	pF	

**Electrical Characteristics** (@T<sub>A</sub> = -40°C to +105°C, unless otherwise specified.)

ULN2003A								
Parameter	Test Figure	Test Conditions	Min	Typ	Max	Unit		
V <sub>I(on)</sub>	On State Input Voltage	6	V <sub>CE</sub> = 2V	I <sub>C</sub> = 200mA	-	-	2.7	V
				I <sub>C</sub> = 250mA	-	-	2.9	
				I <sub>C</sub> = 300mA	-	-	3	
V <sub>CE(sat)</sub>	Collector Emitter Saturation Voltage	5	I <sub>I</sub> = 250µA, I <sub>C</sub> = 100mA	-	0.9	1.2	V	
			I <sub>I</sub> = 350µA, I <sub>C</sub> = 200mA	-	1	1.4		
			I <sub>I</sub> = 500µA, I <sub>C</sub> = 350mA	-	1.2	1.7		
V <sub>F</sub>	Clamp Forward Voltage	8	I <sub>F</sub> = 350mA	-	1.7	2.2	V	
I <sub>CEX</sub>	Collector Cut-off Current	1	V <sub>CE</sub> = 50V, I <sub>I</sub> = 0	-	-	100	µA	
I <sub>I(off)</sub>	Off State Input Current	3	V <sub>CE</sub> = 50V, I <sub>C</sub> = 500µA	30	65	-	µA	
I <sub>I</sub>	Input Current	4	V <sub>I</sub> = 3.85V	-	0.93	1.35	mA	
I <sub>R</sub>	Clamp Reverse Current	7	V <sub>R</sub> = 50V	-	-	100	µA	
C <sub>I</sub>	Input Capacitance	-	V <sub>I</sub> = 0, f = 1MHz	-	15	25	pF	

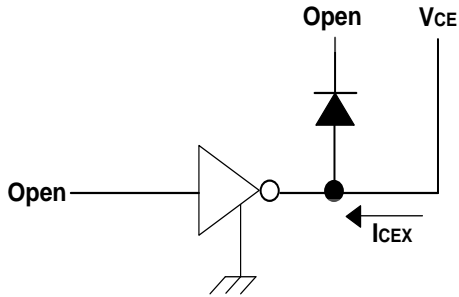
**Switching Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

ULN2002A, ULN2003A, ULN2004A						
Parameter	Test figure	Min	Typ	Max	Unit	
t <sub>PLH</sub>	Propagation delay time, low to high level output	10	-	0.25	1	µs
t <sub>PLL</sub>	Propagation delay time, high to low level output	10	-	0.25	1	µs
V <sub>OH</sub>	High level output voltage after switching	10 (V <sub>S</sub> = 50V, I <sub>O</sub> = 300mA)	V <sub>S</sub> -20	-	-	mV

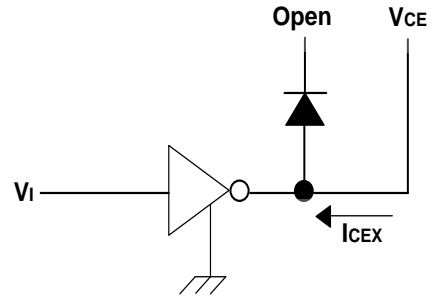
**Switching Characteristics** (@T<sub>A</sub> = -40 to +105°C, unless otherwise specified.)

ULN2003A						
Parameter	Test figure	Min	Typ	Max	Unit	
t <sub>PLH</sub>	Propagation delay time, low to high level output	10	-	1	10	µs
t <sub>PLL</sub>	Propagation delay time, high to low level output	10	-	1	10	µs
V <sub>OH</sub>	High level output voltage after switching	10 (V <sub>S</sub> = 50V, I <sub>O</sub> = 300mA)	V <sub>S</sub> -50	-	-	mV

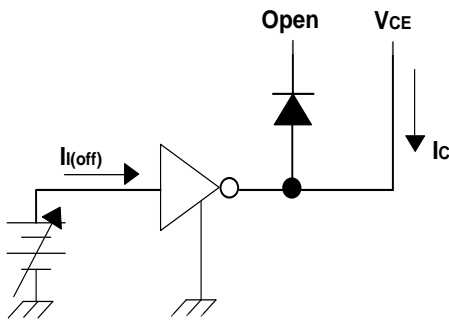
**Parameter Measurement Circuits**



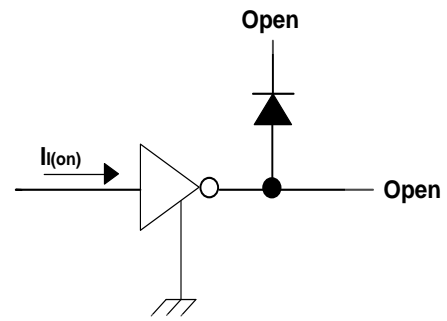
**Fig.1** ICEX Test Circuit



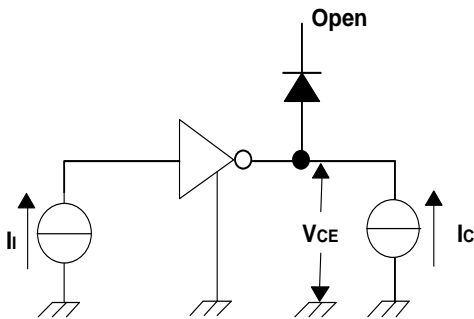
**Fig.2** ICEX Test Circuit



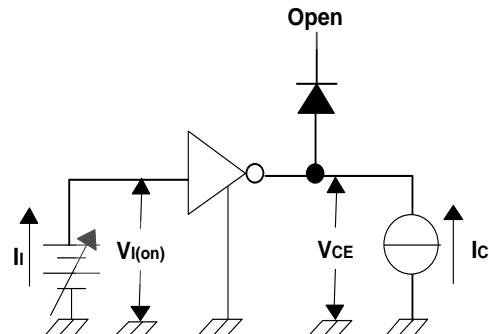
**Fig.3** I<sub>(off)</sub> Test Circuit



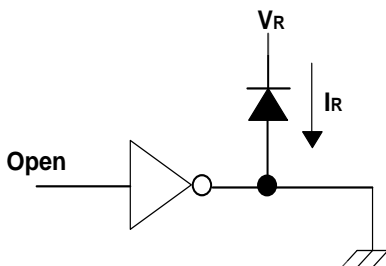
**Fig.4** I<sub>(on)</sub> Test Circuit



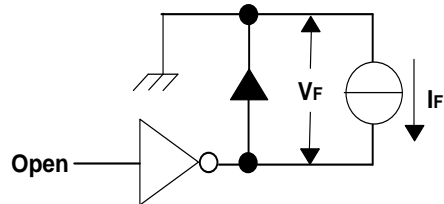
**Fig. 5**  $h_{FE}$  ,  $V_{CE(sat)}$  Test Circuit



**Fig. 6**  $V_{I(on)}$  Test Circuit

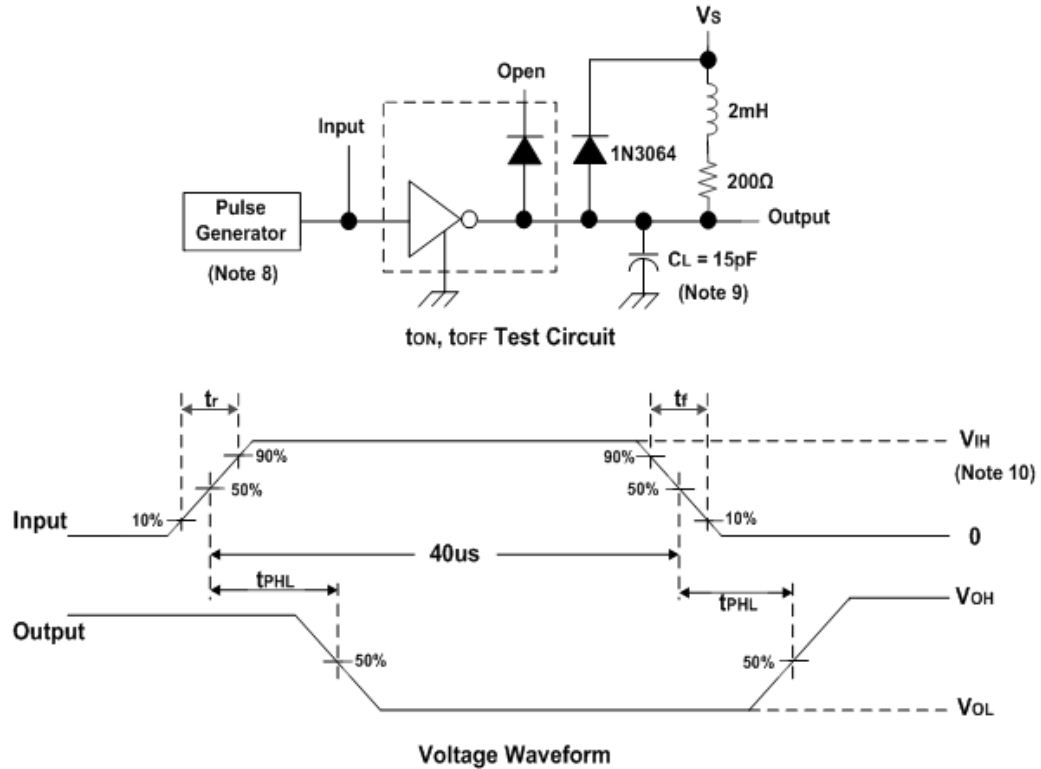


**Fig. 7** I<sub>R</sub> Test Circuit



**Fig. 8**  $V_F$  Test Circuit

**Parameter Measurement Circuits (continued)**



**Fig. 10 Latch-Up Test Circuit and Voltage Waveform**

- Notes:
- 8. The pulse generator has the following characteristics: Pulse Width = 12.5Hz, output impedance 50Ω,  $t_r \leq 5\text{ns}$ ,  $t_f \leq 10\text{ns}$ .
  - 9.  $C_L$  includes probe and jig capacitance.
  - 10. For testing the ULN2002A,  $V_{IH} = 13\text{V}$ ; for the ULN2003A,  $V_{IH} = 3\text{V}$ ; for the ULN2004A,  $V_{IH} = 8\text{V}$ .

**Typical Performance Characteristics**

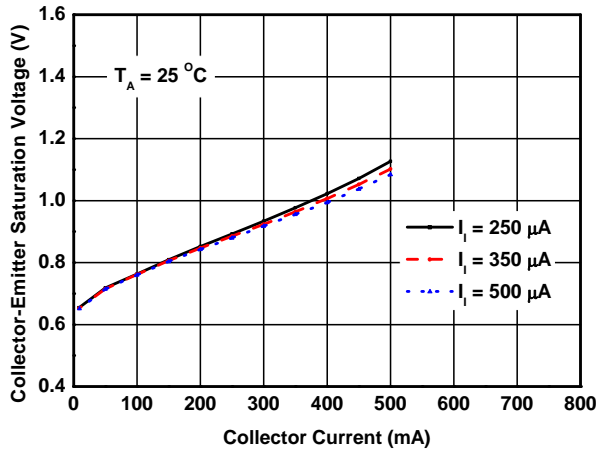


Figure 11 Collector-Emitter Saturation Voltage vs. Collector Current (One Darlington)

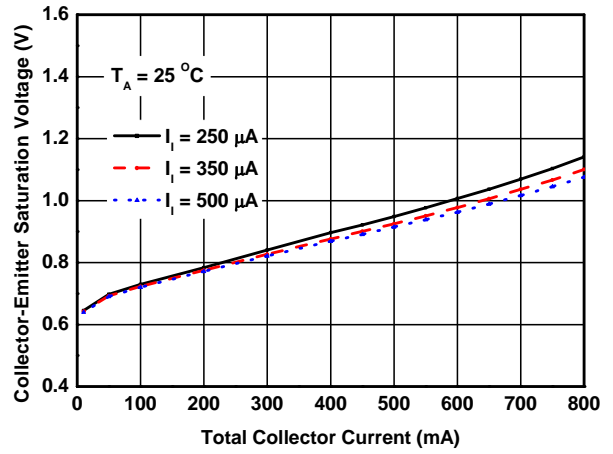


Figure 12 Collector-Emitter Saturation Voltage vs. Collector Current (Two Darlington in Parallel)

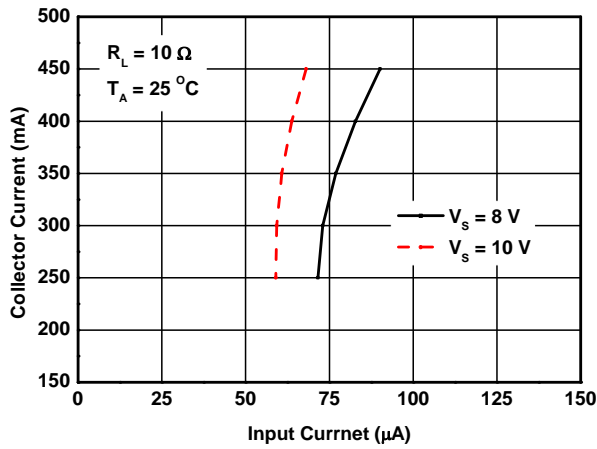


Figure 13 Collector Current vs. Input Current

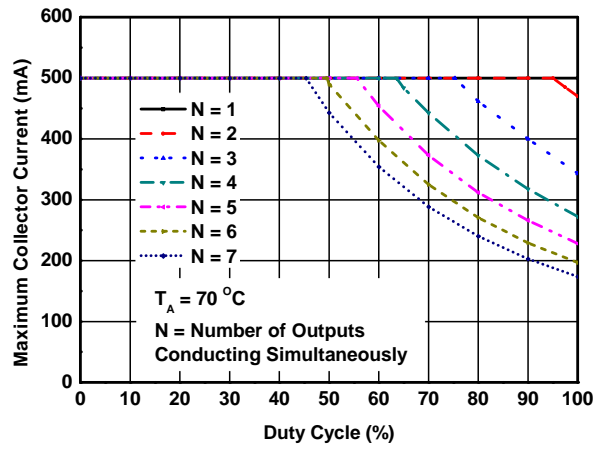


Figure 14 Maximum Collector Current vs. Duty Cycle

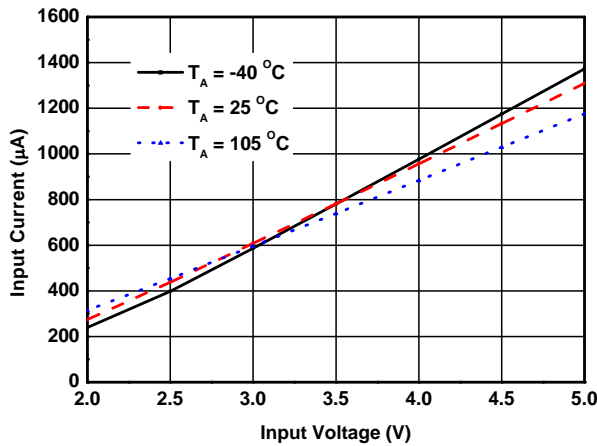


Figure 15. Input Current vs. Input Voltage

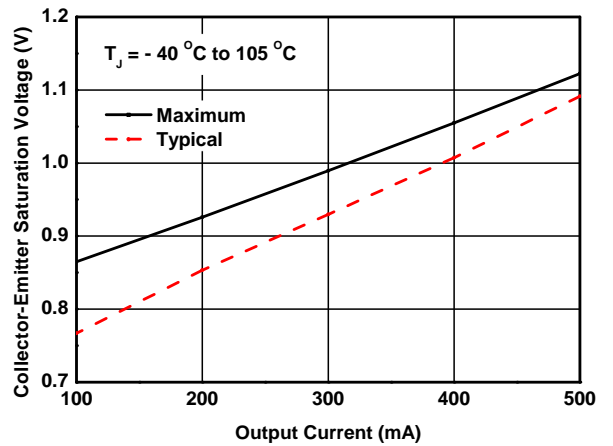


Figure 16. Collector-Emitter Saturation Voltage vs. Output Current



**Typical Performance Characteristics** (continued)

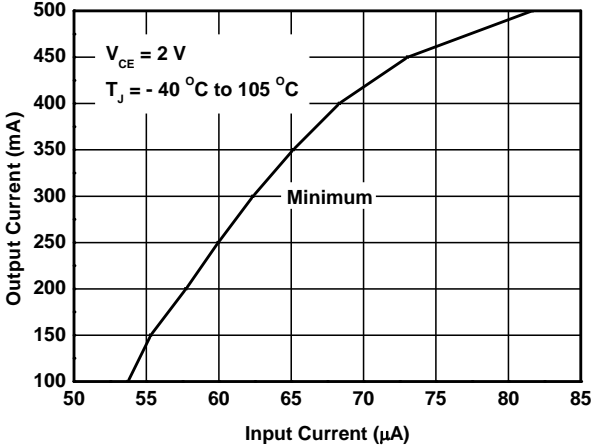
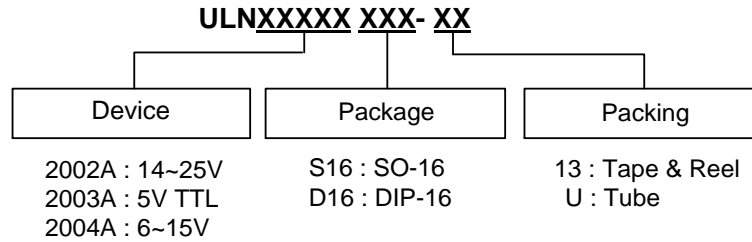


Figure 17. Output Current vs. Input Current

## Ordering Information

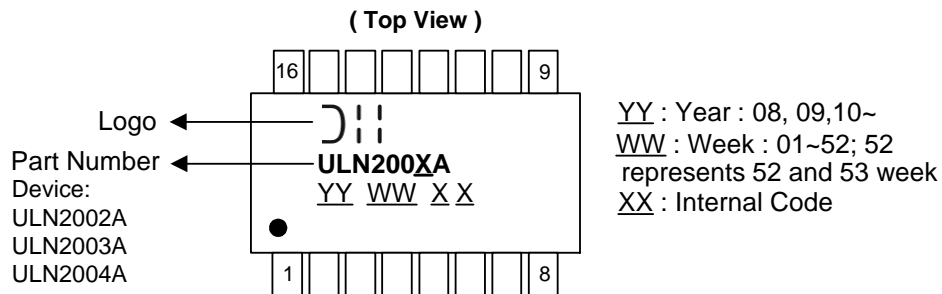


Part Number	Package Code	Packaging	13" Tape and Reel		Tube	
			Quantity	Part Number Suffix	Quantity	Part Number Suffix
ULN2002AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2003AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2004AS16-13	S16	SO-16	2,500/Tape & Reel	-13	NA	NA
ULN2002AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2003AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U
ULN2004AD16-U	D16	PDIP-16	NA	NA	25/Tube	-U

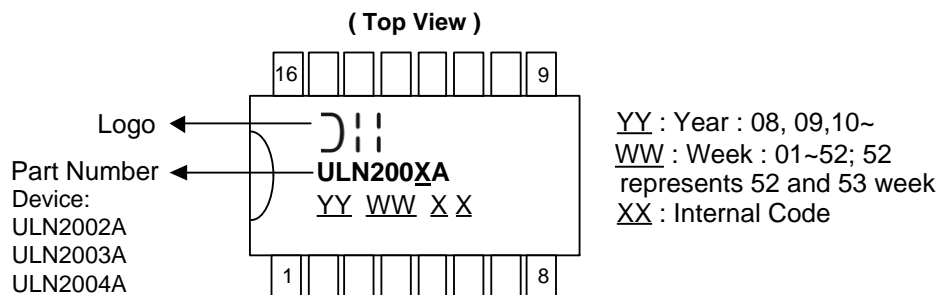
Note: 11. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.

## Marking Information

### (1) SO-16



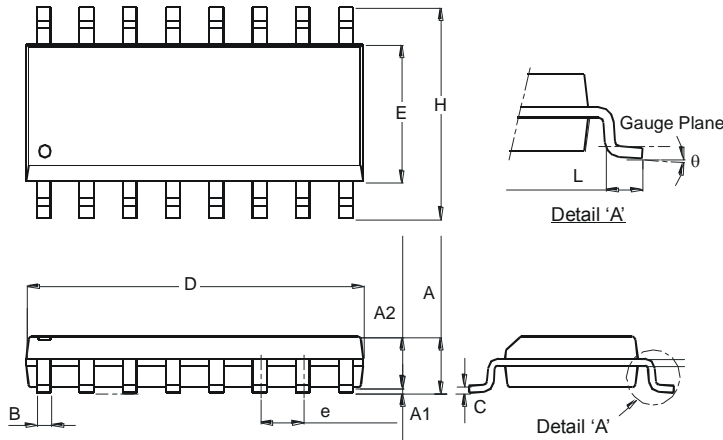
### (2) PDIP-16



**Package Outline Drawings**

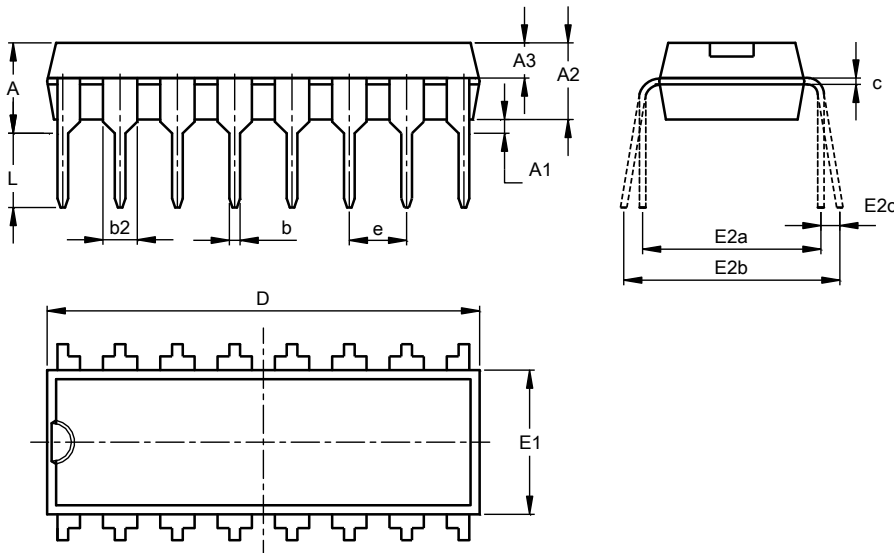
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

**SO-16**



SO-16		
Dim	Min	Max
A	1.40	1.75
A1	0.10	0.25
A2	1.30	1.50
B	0.33	0.51
C	0.19	0.25
D	9.80	10.00
E	3.80	4.00
e	1.27 Typ	
H	5.80	6.20
L	0.38	1.27
$\theta$	0°	8°
All Dimensions in mm		

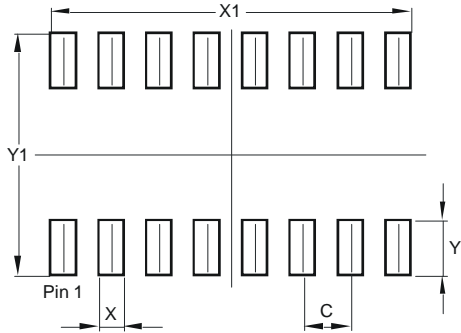
**PDIP-16**



PDIP-16			
Dim	Min	Max	Nom
A	3.60	4.00	3.80
A1	0.51	-	-
A2	3.20	3.40	3.30
A3	1.47	1.57	1.52
b	0.44	0.53	-
b2	1.52BSC		
c	0.25	0.31	-
D	18.90	19.30	19.10
E1	6.15	6.55	6.35
E2a	7.62 BSC		
E2b	7.62	9.30	-
E2c	0.00	0.84	-
e	2.54BSC		
L	3.00	-	-
All Dimensions in mm			

**Suggested Pad Layout**

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	1.270
X	0.670
X1	9.560
Y	1.450
Y1	6.400

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**LIFE SUPPORT**

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

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Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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